

L Number	Hits	Search Text	DB	Time stamp
1	1516	("604.525").PN. or (("600/585") or ("600/114") or ("600/434") or ("604/170.01") or ("604/107.03") or ("604/526")).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/11/20 13:17
2	1207	((("604.525").PN. or (("600/585") or ("600/114") or ("600/434") or ("604/170.01") or ("604/107.03") or ("604/526")).CCLS.) and guide\$	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/11/20 13:17
3	576	((("604.525").PN. or (("600/585") or ("600/114") or ("600/434") or ("604/170.01") or ("604/107.03") or ("604/526")).CCLS.) and guide\$) and guidewire\$	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/11/20 13:18
4	257	((("604.525").PN. or (("600/585") or ("600/114") or ("600/434") or ("604/170.01") or ("604/107.03") or ("604/526")).CCLS.) and guide\$) and guidewire\$) and alloys	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/11/20 13:18
-	1610	((("600/585") or ("600/114") or ("600/434") or ("604/170.01") or ("604/107.03") or ("604/525") or ("604/526")).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/11/20 11:46
-	0	((("600/585") or ("600/114") or ("600/434") or ("604/170.01") or ("604/107.03") or ("604/525") or ("604/526")).CCLS.) and BioDur	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/11/20 11:46
-	2	biodur	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/11/20 11:46
-	47	biodur\$	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/11/20 11:46
-	1	biodur\$ and guidewire\$	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/11/20 11:50
-	606	((("600/585") or ("600/114") or ("600/434") or ("604/170.01") or ("604/107.03") or ("604/525") or ("604/526")).CCLS.) and guidewire\$	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/11/20 11:51

			USPAT;	2001/11/20
-	4	(((600/585 600/114 600/434 604/170.01 604/107.01 604/525 602/526).C2A.S.) and guidewire\$) and (nickel xor Ni xor NiTi xor nitinol xor Ni-Ti)) and heat-treat\$	US-PGPUB; EPO; JPO; DERWENT; IBM TDB	11:58
-	3	(alloy not (nickel or Ni or NiTi or nitinol or Ni-Ti)) and (guidewire same heat-treat\$)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/11/20 12:22
-	0	(percent near5 (nickel or Ni)) and (guidewire same heat-treat\$)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/11/20 12:08
-	32	(percent near5 (nickel or Ni)) and guidewire	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/11/20 12:38
-	9	((guidewire or obturator or stylet) same (alloy not (nickel or Ni or NiTi or nitinol))) and (heat near3 treat\$)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/11/20 12:26
-	0	(guidewire or obturator or stylet) same (alloy same ((trace or minimal or negligible or small) near5 (nickel or Ni or NiTi or nitinol))) and (heat near3 treat\$)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/11/20 12:30
-	33	(guidewire or obturator or stylet) and (alloy same ((trace or minimal or negligible or small) near5 (nickel or Ni or NiTi or nitinol)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/11/20 12:31
-	2	((percent near5 composition) near5 (nickel or Ni)) and guidewire	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/11/20 12:42
-	19	((percent near5 composition) same (nickel or Ni)) and guidewire	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/11/20 12:43